



## EOL of 30nm LPDDR2 2Gb-based (U89N) Parts

All Sites

PCN: 31910

Published: 2016-06-21

**Micron Sites Affected:** 

Type:	End of Life	
Description:	Micron's 30nm LPDDR2 2Gb-based (U89N) parts are being replaced by 25nm process technology parts (U98M DDP). With this change, solderball composition will change for some parts listed from SAC305 to SAC302. Please refer to the datasheet for additional details.	
Reason:	Manufacturing Efficiency	
Product Affected:	30nm LPDDR2 2Gb-based (U89N) Parts	
Affected Micron Part Number	Recommended Replacement	<b>Customer Part Number</b>
Component		
MT42L64M32D1LF-18 IT:C	No replacement	
MT42L64M32D1TK-18 AAT:0	EDB2432B4MA-1DAAT-F-R	
MT42L64M32D1TK-18 IT:C	EDB2432B4MA-1DIT-F-R	
MT42L64M64D2LL-18 IT:C	EDB4064B4PB-1DIT-F-R	
MT42L64M64D2LL-18 WT:C	EDB4064B4PB-1DIT-F-R	
	*Materials that have been ordered are	in <b>bold</b> .

Sample Available:	2016-04-15
Qual Data Available:	2016-06-20
Last Purchase Date*:	2016-12-21
Last Shipment Date:	2017-06-21

<sup>\*</sup>Orders placed prior to the last purchase date are subject to current inventory levels, which may vary based on market conditions and customer demand. Early orders are encouraged.

NOTE: Per JEDEC Standard JESD46-C Section 3.2.3; lack of acknowledgment of this PCN within 30 days constitutes acceptance of change.

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